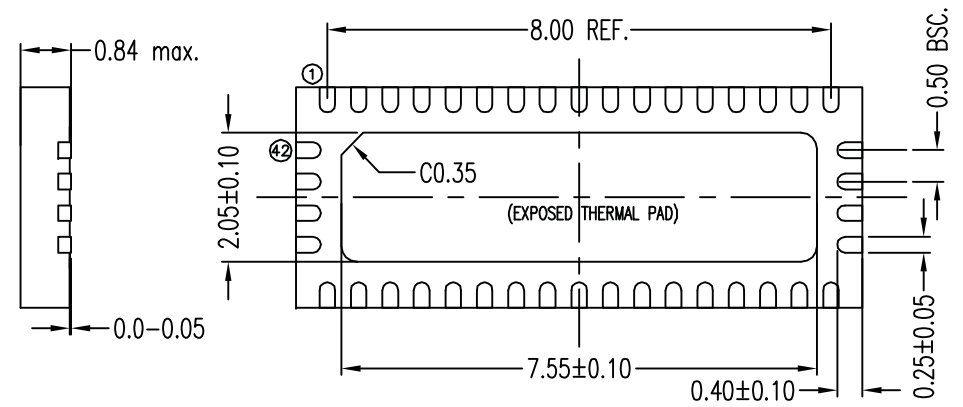
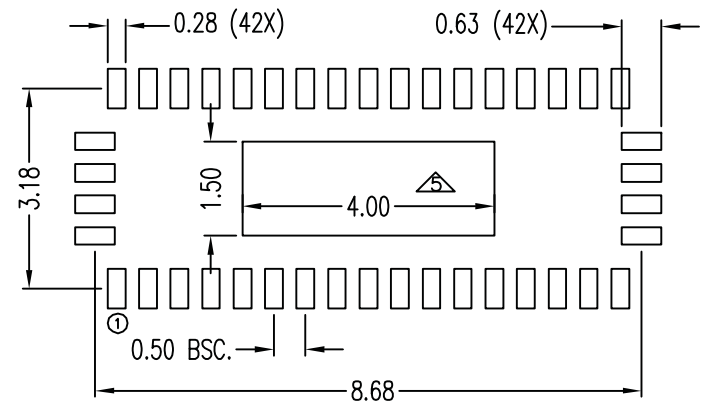
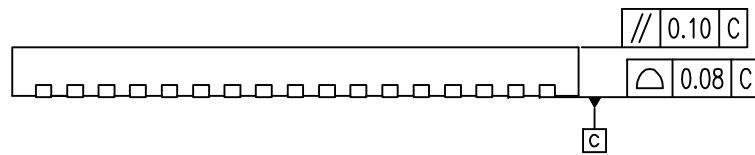


TOP VIEW



BOTTOM VIEW



RECOMMENDED LAND PATTERN (TOP VIEW)

Notes:

1. All dimensions are in millimeters, angles in degrees.
2. Coplanarity applies to the exposed thermal pad as well as the terminals.
3. Refer JEDEC MO-220
4. Recommended Land Pattern is for reference only.
5. Thermal Pad Soldering Area



DATE: 02/17/09

DESCRIPTION: 42-contact Thin Fine Pitch Quad Flat No-Lead (TQFN)

PACKAGE CODE: ZH (ZH42)

DOCUMENT CONTROL #: PD-2035

REVISION: C